

## Discrete POWER & Signal **Technologies**

## **FDH / FDLL 600**





THE PLACEMENT OF THE EXPANSION GAP HAS NO RELATIONSHIP TO THE LOCATION OF THE CATHODE TERMINAL

COLOR BAND MARKING DEVICE 1ST BAND 2ND BAND WHITE FDLL600 RED

## **High Conductance Ultra Fast Diode**

Sourced from Process 1R. See MMBD1201-1205 for characteristics.

## **Absolute Maximum Ratings\***

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$W_{IV}$	Working Inverse Voltage	50	V
Io	Average Rectified Current	200	mA
I <sub>F</sub>	DC Forward Current	400	mA
İf	Recurrent Peak Forward Current	600	mA
İf(surge)	Peak Forward Surge Current Pulse width = 1.0 second Pulse width = 1.0 microsecond	1.0 4.0	A A
T <sub>stg</sub>	Storage Temperature Range	-65 to +200	°C
T <sub>J</sub>	Operating Junction Temperature	175	°C

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- These ratings are based on a maximum junction temperature of 200 degrees C.
   These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

## **Thermal Characteristics**

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max	Units
		FDH/FDLL 600	
P <sub>D</sub>	Total Device Dissipation	500	mW
	Derate above 25°C	3.33	mW/°C
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	300	°C/W

# High Conductance Ultra Fast Diode (continued)

## **Electrical Characteristics**

TA = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
B <sub>V</sub>	Breakdown Voltage	$I_R = 5.0 \mu A$	75		V
I <sub>R</sub>	Reverse Current	V <sub>R</sub> = 50 V V <sub>R</sub> = 50 V, T <sub>A</sub> = 150°C		100 100	nA μA
V <sub>F</sub>	Forward Voltage	$I_{F} = 1.0 \text{ mA}$ $I_{F} = 10 \text{ mA}$ $I_{F} = 50 \text{ mA}$ $I_{F} = 100 \text{ mA}$ $I_{F} = 200 \text{ mA}$		650 790 860 920 1.0	mV mV mV mV
Co	Diode Capacitance	V <sub>R</sub> = 0, f = 1.0 MHz		2.5	pF
$T_RR$	Reverse Recovery Time	$\begin{split} I_F &= I_R = 10 \text{ mA}, \ I_{rr} = 1.0 \text{ mA}, \\ R_L &= 100 \ \Omega \\ I_F &= I_R = 200 \text{ mA}, \ I_{rr} = 20 \text{ mA}, \\ R_L &= 100 \ \Omega \end{split}$		4.0 6.0	nS nS

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## PRODUCT STATUS DEFINITIONS

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Datasheet Identification	Product Status	Definition
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